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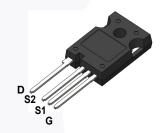
# FCH041N65EFL4 N-Channel SuperFET<sup>®</sup> II FRFET<sup>®</sup> MOSFET 650 V, 76 A, 41 mΩ

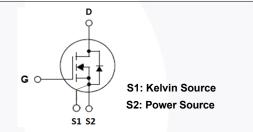
## Features

- 700 V @ T<sub>J</sub> = 150°C
- Typ. R<sub>DS(on)</sub> = 36 mΩ
- Ultra Low Gate Charge (Typ. Q<sub>g</sub> = 229 nC)
- Low Effective Output Capacitance (Typ. C<sub>oss(eff.)</sub> = 631 pF)
- 100% Avalanche Tested
- RoHS Compliant

## Applications

- LCD / LED / PDP TV 
   Telecom / Server Power Supplies
- Solar Inverter
- AC DC Power Supply





SuperFET<sup>®</sup> II MOSFET is Fairchild Semiconductor's brand-new high voltage super-junction (SJ) MOSFET family that is utilizing

charge balance technology for outstanding low on-resistance

and lower gate charge performance. This technology is tailored

to minimize conduction loss, provide superior switching performance, dv/dt rate and higher avalanche energy. Consequently,

SuperFET II MOSFET is very suitable for the switching power

applications such as PFC, server/telecom power, FPD TV power, ATX power and industrial power applications. SuperFET

I FRFET<sup>®</sup> MOSFET's optimized body diode reverse recovery performance can remove additional component and improve

Description

system reliability.

#### Absolute Maximum Ratings T<sub>C</sub> = 25°C unless otherwise noted.

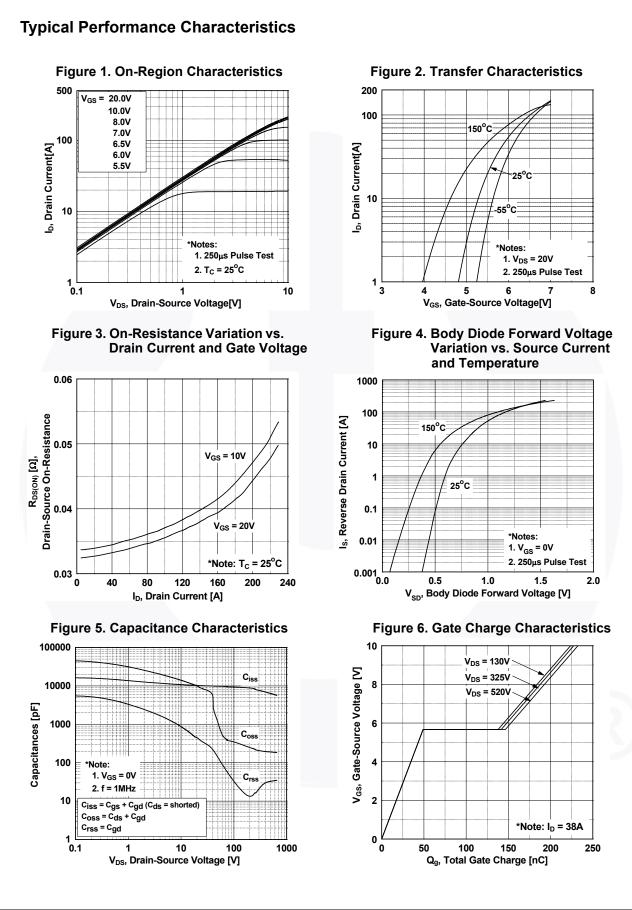
Symbol		FCH041N65EFL4	Unit			
V <sub>DSS</sub>	Drain to Source Voltage		650	V		
V <sub>GSS</sub>	Cata ta Cauraa Maltaga	- DC - AC (f > 1 Hz)		±20	V	
	Gate to Source Voltage			±30	v	
I <sub>D</sub>	Drain Current	- Continuous (T <sub>C</sub> = 25 <sup>o</sup> C)		76	٨	
		- Continuous (T <sub>C</sub> = 100 <sup>o</sup> C)		48.1	A	
I <sub>DM</sub>	Drain Current	- Pulsed	(Note 1)	228	Α	
E <sub>AS</sub>	Single Pulsed Avalanche Energy (Note 2)			2025	mJ	
I <sub>AR</sub>	Avalanche Current			15	Α	
E <sub>AR</sub>	Repetitive Avalanche Energy (Not			5.95	mJ	
du/dt	MOSFET dv/dt	100	V/ns			
dv/dt	Peak Diode Recovery dv/dt (Note 3)				50	
P <sub>D</sub>	Devuer Dissingtion	(T <sub>C</sub> = 25 <sup>o</sup> C)		595	W	
	Power Dissipation	- Derate Above 25°C		4.76	W/ºC	
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Temperature Range			-55 to +150	°C	
TL	Maximum Lead Temperature for Soldering, 1/8" from Case for 5 Seconds			300	°C	

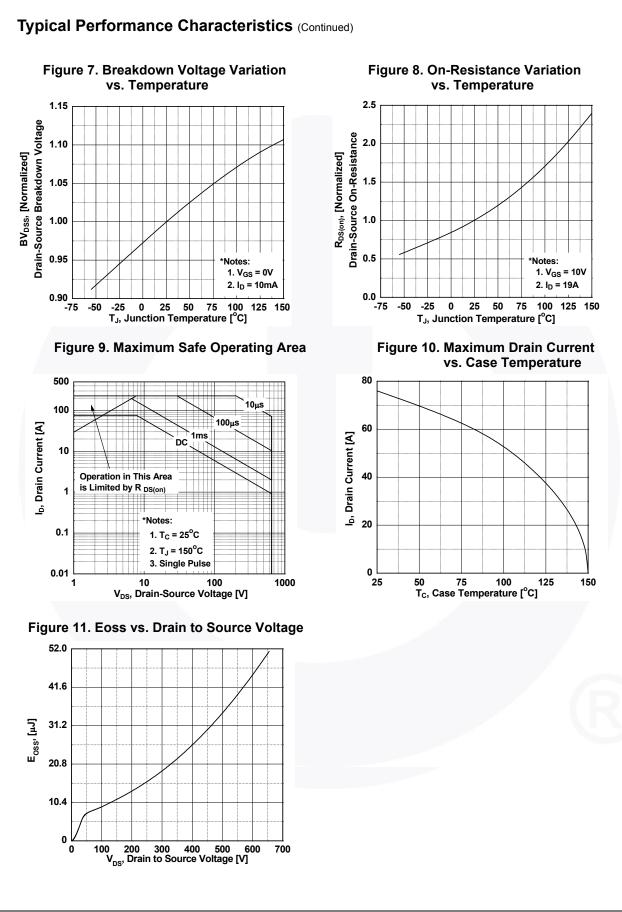
#### Thermal Characteristics

Symbol	Parameter	FCH041N65EFL4	Unit	
$R_{ ext{ heta}JC}$	Thermal Resistance, Junction to Case, Max.	0.21	°C/W	
$R_{ hetaJA}$	Thermal Resistance, Junction to Ambient, Max.	40	°C/W	

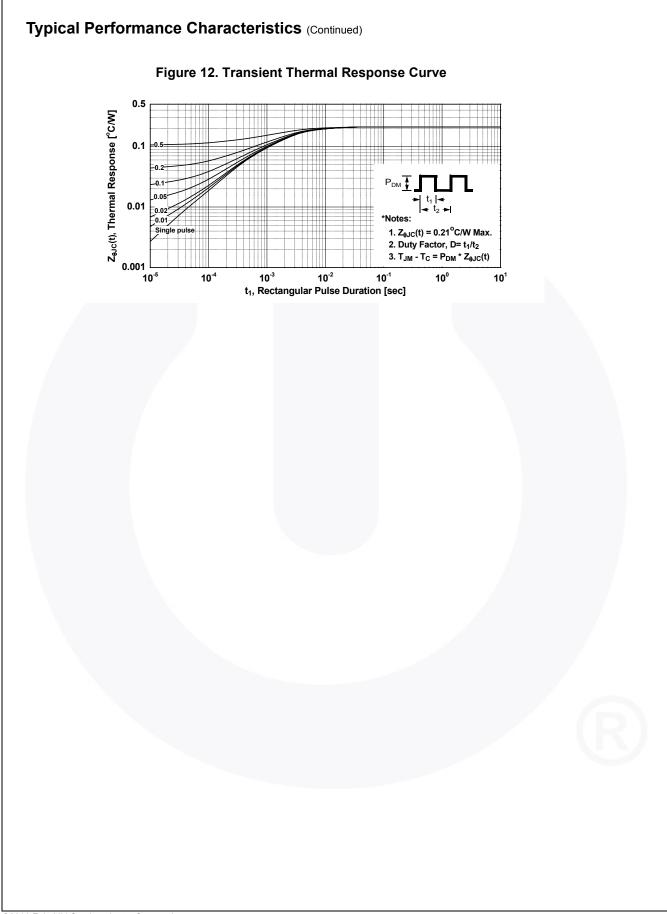
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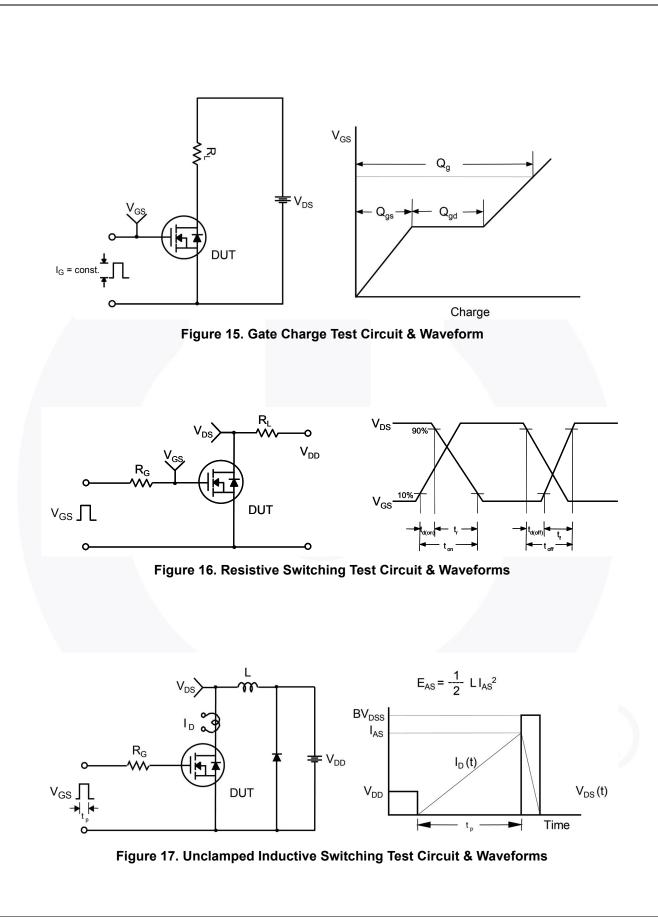
Part Number FCH041N65EFL4		Top Mark	Package	Packing Method Reel Size		Таре	e Width	Qua	ntity
		FCH041N65EF	TO-247 4L	Tube	N/A		N/A	30 u	inits
Electrica	Char	octorictics -	0500						
Symbol		acteristics ⊤ <sub>C</sub> = Parameter	25°C unless	otherwise noted. Test Conditi	iono	Min.	Tun	Max.	Unit
				Test Conditi	0115	IVIIII.	Тур.	IVIAX.	UIII
Off Charac	teristics	6					1	1	1
BV <sub>DSS</sub>	Drain to	rain to Source Breakdown Voltage		$V_{GS} = 0 V, I_{D} = 10 mA, T_{J} = 25^{\circ}C$		650	-	-	V
				$V_{GS} = 0 \text{ V}, \text{ I}_{D} = 10 \text{ mA}, \text{ T}_{J} = 150 \text{ °C}$ $I_{D} = 10 \text{ mA}, \text{ Referenced to } 25^{\circ}\text{C}$		700	-	-	
∆BV <sub>DSS</sub> / ∆T <sub>.1</sub>	Coefficie	own Voltage Temperature ent				-	0.72	-	V/ºC
<u> </u>				V <sub>DS</sub> = 650 V, V <sub>GS</sub> = 0 V		-	-	10	
DSS	Zero Ga	Zero Gate Voltage Drain Current Gate to Body Leakage Current		$V_{\rm DS} = 520 \text{ V}, \text{ T}_{\rm C} = 125^{\circ}\text{C}$		-	145	-	μA
GSS	Gate to			$V_{GS} = \pm 20 \text{ V}, \text{ V}_{DS} = 0$		-	-	±100	nA
								1	
On Charac									1
V <sub>GS(th)</sub>		reshold Voltage		$V_{GS} = V_{DS}, I_{D} = 7.6 \text{ m}.$	A	3	-	5	V
R <sub>DS(on)</sub>		rain to Source On Res	sistance	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 38 A		-	36	41	mΩ
9 <sub>FS</sub>	Forward	Transconductance		$V_{DS}$ = 20 V, $I_{D}$ = 38 A		-	71.7	-	S
Dynamic C	haracte	ristics							
C <sub>iss</sub>	Input Capacitance					-	9446	12560	pF
C <sub>oss</sub>	-	Capacitance		V <sub>DS</sub> = 100 V, V <sub>GS</sub> = 0 V,		-	366	490	pF
C <sub>rss</sub>		Transfer Capacitance	e	_f = 1 MHz	-	_	35	_	pF
C <sub>oss</sub>		Capacitance		V <sub>DS</sub> = 380 V, V <sub>GS</sub> = 0 V, f = 1 MHz		-	197	-	pF
C <sub>oss(eff.)</sub>	-	e Output Capacitance		$V_{DS} = 0 V \text{ to } 400 V, V_{GS} = 0 V$ $V_{DS} = 380 V, I_D = 38 A,$			631	-	pF
Q <sub>g(tot)</sub>		ate Charge at 10V				-	229	298	nC
Q <sub>gs</sub>		Source Gate Charge		$V_{GS} = 10 V$	.,	-	50	-	nC
Q <sub>gd</sub>	Gate to	Drain "Miller" Charge			(Note 4)	-	90	-	nC
ESR	Equivale	ent Series Resistance		f = 1 MHz		-	0.6	-	Ω
Switching	Charaot	ariatiaa							
Switching								400	r
t <sub>d(on)</sub>		Delay Time		V <sub>DD</sub> = 380 V, I <sub>D</sub> = 38 A,			55	120	ns
t <u>r</u>		Turn-On Rise Time		$V_{GS} = 10 \text{ V}, \text{ R}_{g} = 4.7 \Omega$		-	25	60	ns
t <sub>d(off)</sub>	Turn-Off Delay Time Turn-Off Fall Time					-	169	348	ns
t <sub>f</sub>	Turn-Off	Fail Time			(Note 4)		18	46	ns
Drain-Sou	rce Diod	le Characteristic	s						
Maximum Continuous Drain to Source Diode Forward Current						-	-	76	Α
I <sub>SM</sub>	Maximur	um Pulsed Drain to Source Diode Fo		rward Current		-	-	228	Α
V <sub>SD</sub>	Drain to	Source Diode Forwar	d Voltage	V <sub>GS</sub> = 0 V, I <sub>SD</sub> = 38 A		-		1.2	V
t <sub>rr</sub>	Reverse	Recovery Time		V <sub>GS</sub> = 0 V, I <sub>SD</sub> = 38 A,		-	207	-	ns
Q <sub>rr</sub>	Reverse	Recovery Charge		dI <sub>F</sub> /dt = 100 A/µs		-	1.5	-	μC
lotes:								1	
. Repetitive rating	g: pulse width	limited by maximum junction	temperature.						
2. I <sub>AS</sub> = 15 A, R <sub>G</sub> =									
		$V_{DD} \le 380$ V, starting T <sub>J</sub> = 25° erating temperature typical c							
	pendent of op	crating temperature typical e	naraciensiics.						



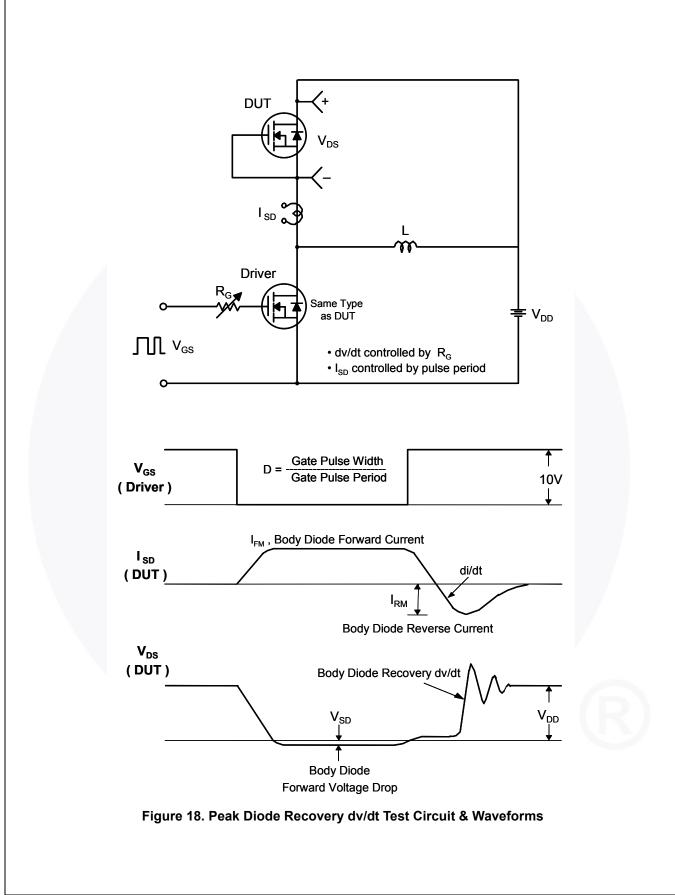


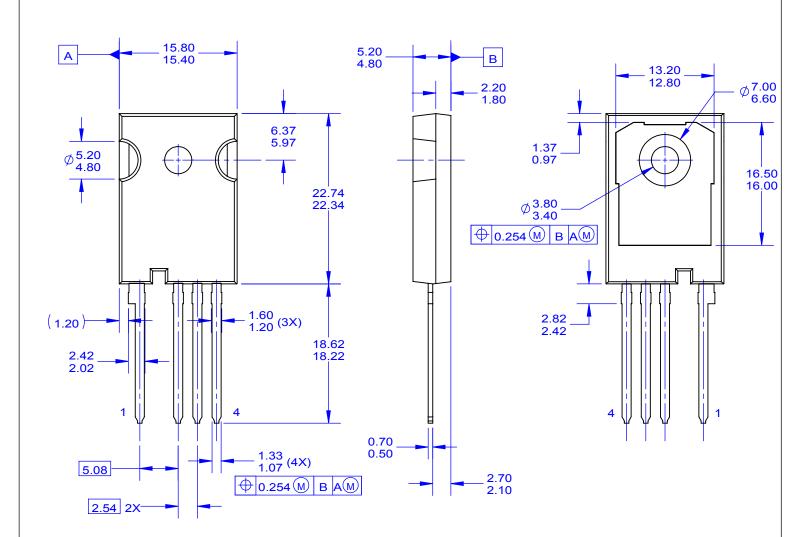
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FCH041N65EFL4 — N-Channel SuperFET<sup>®</sup> II FRFET<sup>®</sup> MOSFET





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